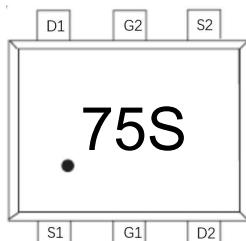


Features

- High-Side Switching
- Low Threshold
- Fast Switching Speed

Application

- Load/ Power Switching
- Interfacing Switching
- Battery Management for Ultra Small Portable Electronics



75S: Device code

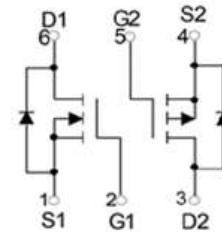
Marking and pin assignment

Product Summary

V _{DS}	R _{DS(ON)} MAX	I _D MAX
50V	5Ω@10V	0.34A
	5.3Ω@4.5V	
-50V	8Ω@-10V	-0.18A
	10Ω@-4.5V	



SOT-563 top view



Schematic diagram



Halogen-Free

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	N-Channel	P-Channel	Unit
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Common Ratings (TC=25°C Unless Otherwise Noted)

V _{DS}	Drain-Source Breakdown Voltage	50	-50	V
V _{GS}	Gate-Source Voltage	±20	±20	V
T _J	Maximum Junction Temperature	150	150	°C
T _{STG}	Storage Temperature Range	-55 to 150	-55 to 150	°C
I _S	Diode Continuous Forward Current	Tc=25°C 0.34	-0.18	A

Mounted on Large Heat Sink

I _{DM}	Pulse Drain Current Tested	Tc=25°C 1	-0.52	A
I _D	Continuous Drain Current	Tc=25°C 0.34	-0.18	A
P _D	Maximum Power Dissipation	Tc=25°C 1.5	1.5	W
R _{θJA}	Thermal Resistance Junction-Ambient	380	380	°C/W

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MLSX7252	SOT-563	75S	3,000	45,000	180,000	7"reel

N-Ch Electrical Characteristics (TJ=25°C unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
$BV_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	50	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=50V, V_{GS}=0V$	--	--	1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	--	--	± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	0.5	0.8	2.5	V
$R_{DS(on)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=0.3A$	--	0.85	5	Ω
		$V_{GS}=5V, I_D=0.2A$	--	1	5.3	Ω
Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
C_{ISS}	Input Capacitance	$V_{DS}=25V, V_{GS}=0V, f=1MHz$	--	42	--	pF
C_{OSS}	Output Capacitance		--	15	--	pF
C_{RSS}	Reverse Transfer Capacitance		--	3	--	pF
Switching Characteristics						
Q_g	Total Gate Charge	$V_{DS}=25V, I_D=0.3A, V_{GS}=4.5V$	--	7	--	nC
Q_{gs}	Gate Source Charge		--	1.8	--	nC
Q_{gd}	Gate Drain Charge		--	0.6	--	nC
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=25V, I_D=0.3A, V_{GS}=4.5V, R_G=10\Omega$	--	4.6	--	nS
t_r	Turn-on Rise Time		--	6.8	--	nS
$t_{d(off)}$	Turn-Off Delay Time		--	19	--	nS
t_f	Turn-Off Fall Time		--	11.5	--	nS
Source- Drain Diode Characteristics						
V_{SD}	Forward on voltage	$T_j=25^\circ C, I_S=0.3A$	--	--	1.2	V

P-Ch Electrical Characteristics (TJ=25°C unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-50	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-50V, V _{GS} =0V	--	--	-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-1	-1.3	-2	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-0.13A	--	3.6	8	Ω
		V _{GS} =-5V, I _D =-0.10A	--	4	10	Ω
Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
C _{ISS}	Input Capacitance	V _{DS} =-25V, V _{GS} =0V, f=1MHz	--	35	--	pF
C _{OSS}	Output Capacitance		--	5	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	2.5	--	pF
Switching Characteristics						
Q _g	Total Gate Charge	V _{DD} =-25V, I _D =-0.13A, V _{GS} =-4.5V	--	1.77	--	nC
Q _{gs}	Gate Source Charge		--	0.57	--	nC
Q _{gd}	Gate Drain Charge		--	0.18	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DD} =-25V, I _D =-0.13A, V _{GS} =-4.5V, R _G =2.5Ω	--	2.5	--	nS
t _r	Turn-on Rise Time		--	1	--	nS
t _{d(off)}	Turn-Off Delay Time		--	16	--	nS
t _f	Turn-Off Fall Time		--	8	--	nS
Source- Drain Diode Characteristics						
V _{SD}	Forward on voltage	T _j =25°C, I _S =-0.13A	--	--	-1.2	V

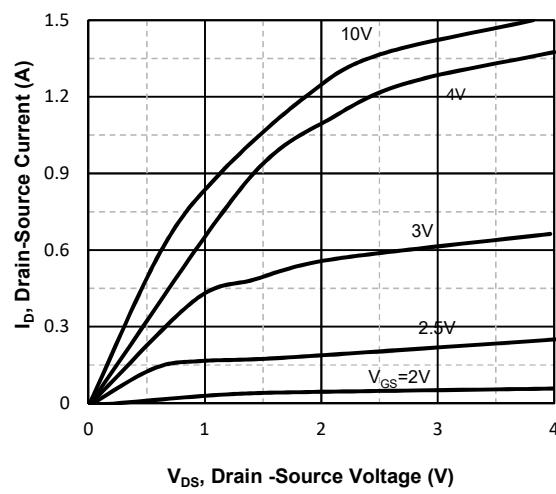
N-Ch Typical Operating Characteristics


Fig1. Typical Output Characteristics

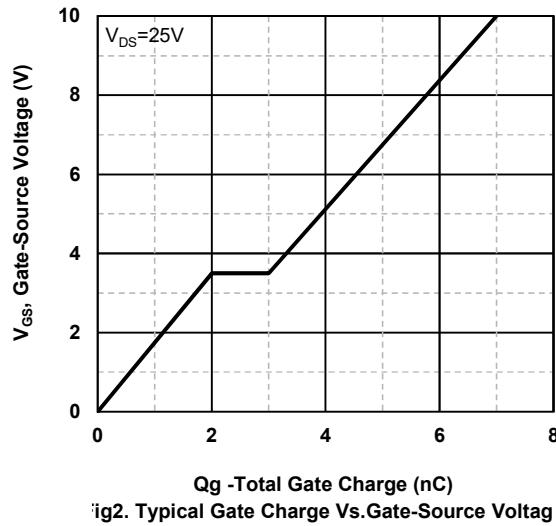


Fig2. Typical Gate Charge Vs. Gate-Source Voltage

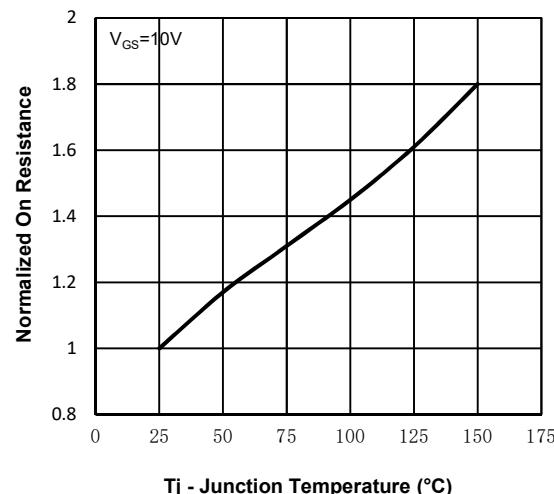


Fig3. Normalized On-Resistance Vs. Temperature

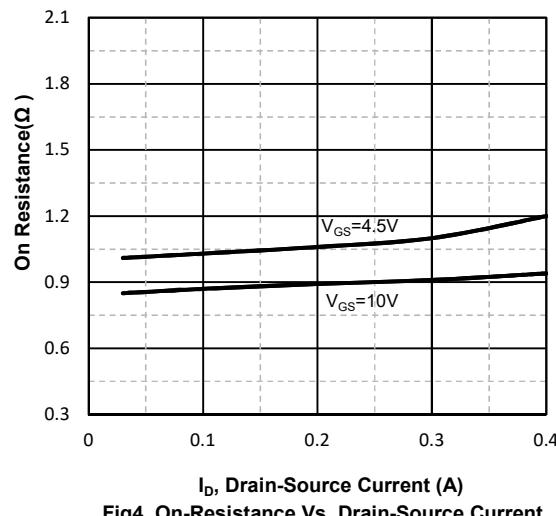


Fig4. On-Resistance Vs. Drain-Source Current

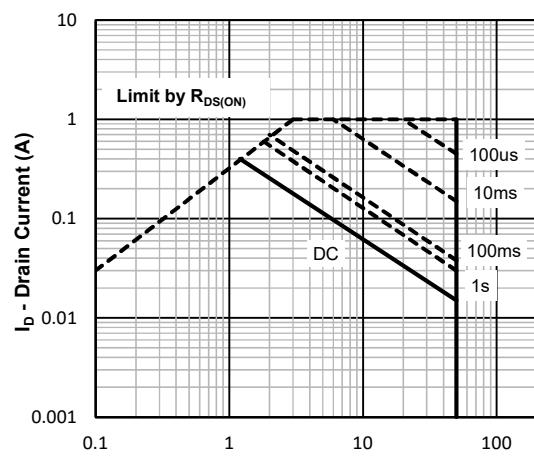


Fig5. Maximum Safe Operating Area

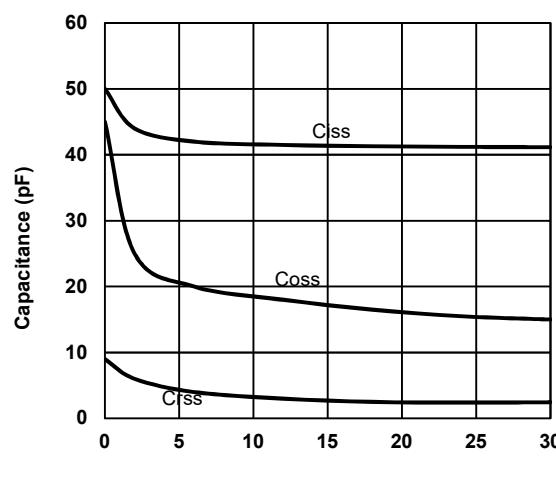


Fig6. Typical Capacitance Vs. Drain-Source Voltage

P-Ch Typical Operating Characteristics

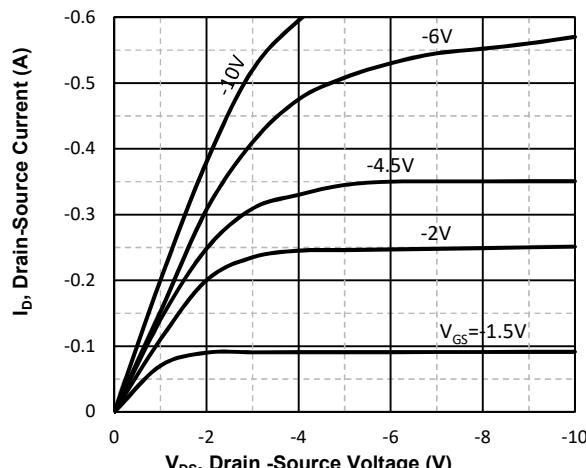


Fig7. Typical Output Characteristics

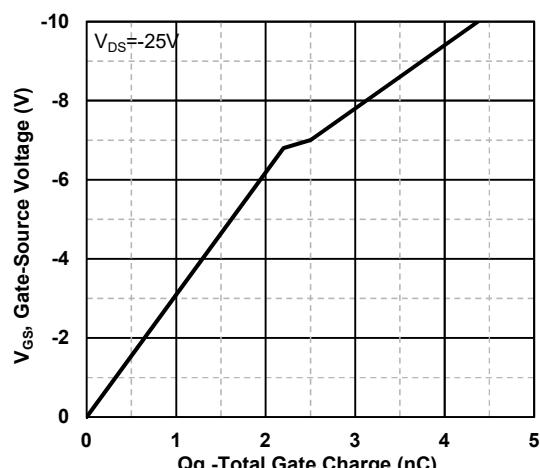


Fig8. Typical Gate Charge Vs.Gate-Source Voltage

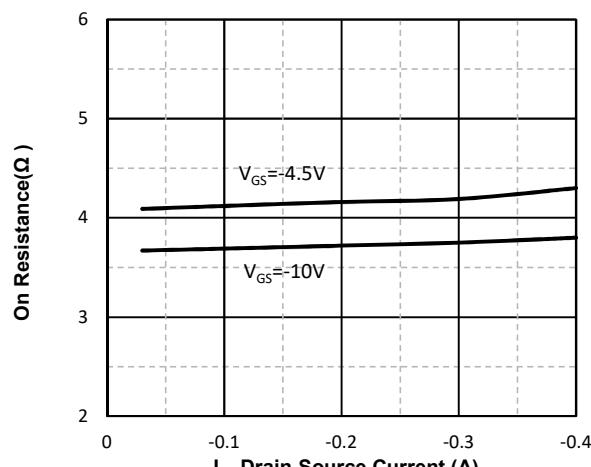


Fig9. On Resistance Vs. Drain-Source Current

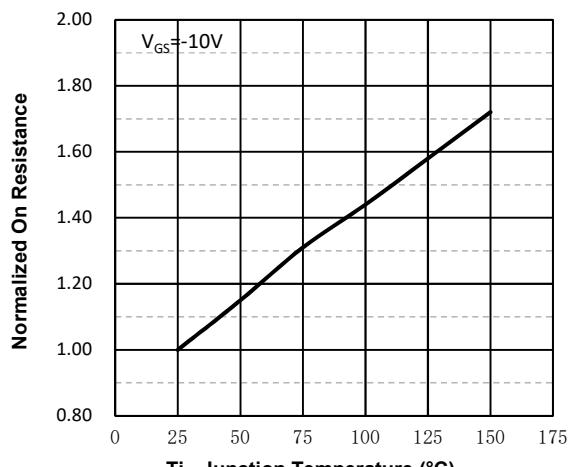


Fig10. Normalized On-Resistance Vs. Temperature

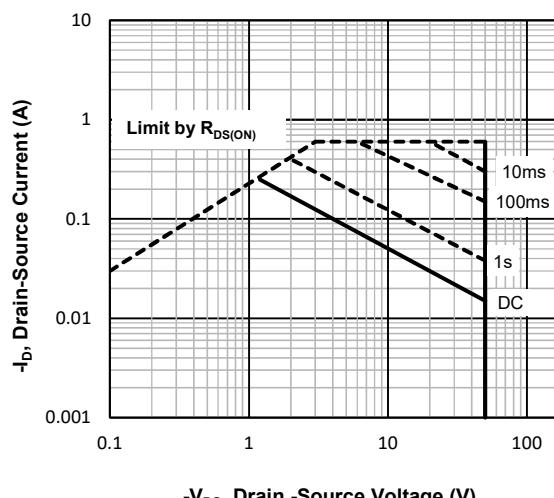


Fig11. Maximum Safe Operating Area

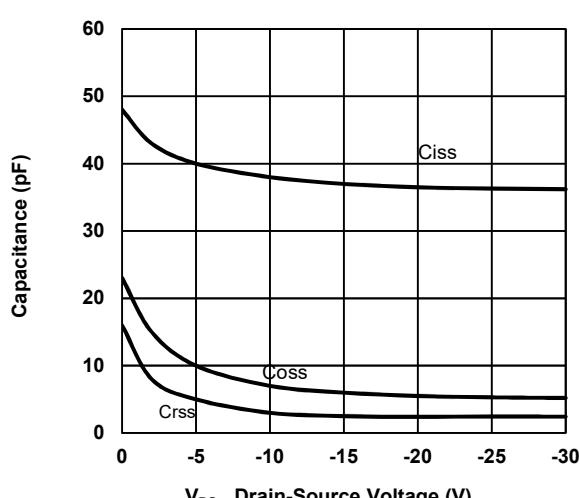
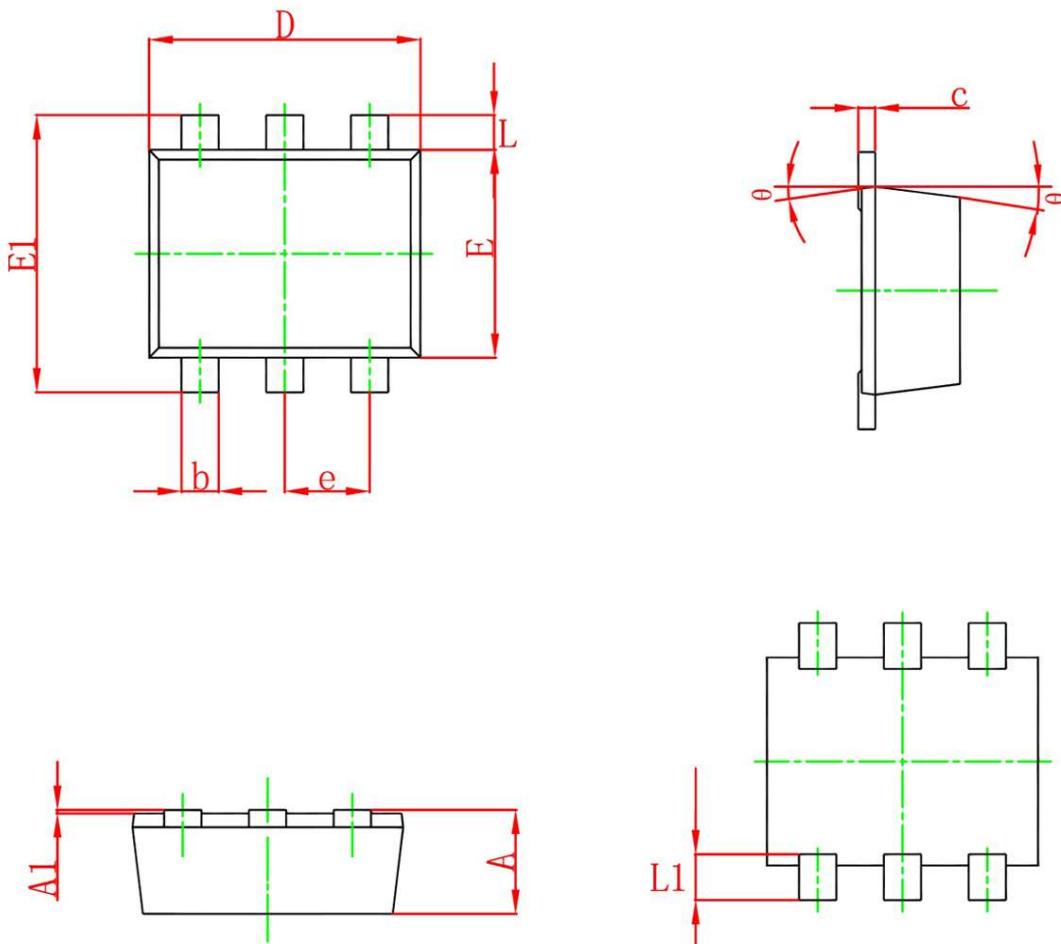


Fig12. Typical Capacitance Vs.Drain-Source Voltage

SOT-563 Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	0.500	0.600	0.020	0.024
A1	0.000	0.050	0.000	0.002
e	0.450	0.550	0.018	0.022
c	0.090	0.180	0.004	0.007
D	1.500	1.700	0.059	0.067
b	0.170	0.270	0.007	0.011
E	1.100	1.300	0.043	0.051
E1	1.500	1.700	0.059	0.067
L	0.100	0.300	0.004	0.012
L1	0.200	0.400	0.008	0.016
θ	10° REF.		10° REF.	